

Title (en)

METHOD FOR FILLING A JOINT WITH AN ADHESIVE AND/OR SEALING MATERIAL AND SYSTEM FOR FILLING A JOINT WITH AN ADHESIVE AND/OR SEALING MATERIAL

Title (de)

VERFAHREN ZUM AUSFÜLLEN EINER FUGE MIT EINEM KLEB- UND/ODER DICHTSTOFF SOWIE SYSTEM ZUM AUSFÜLLEN EINER FUGE MIT EINEM KLEB- UND/ODER DICHTSTOFF

Title (fr)

PROCÉDÉ PERMETTANT DE REMPLIR UN JOINT AVEC UNE MATIÈRE DE COLLAGE ET/OU D'ÉTANCHÉITÉ ET SYSTÈME PERMETTANT DE REMPLIR UN JOINT AVEC UNE MATIÈRE DE COLLAGE ET/OU D'ÉTANCHÉITÉ

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Abstract (en)

[origin: WO2015022391A1] The invention relates to a method for filling a joint (12) with an adhesive and/or sealing material (22), comprising: a) positioning a first part, in particular an insert (11), and a second part, in particular a frame (10), so that the first and second parts form the joint (12); b) introducing a movable spacer (24a to 24h) into the joint (12); c) positioning a nozzle element (23) over the joint (12); d) displacing the nozzle element (23) along the joint (12) such that the nozzle element (23) strikes against the spacer (24a to 24h) and moves the latter forwards; and e) discharging the adhesive and/or sealing material (22) out of an exit nozzle of the nozzle element (23) during step d).

IPC 8 full level

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